

ISCF8019 eq SCT20N170AG

SiC N-Channel MOSFET

FEATURES

- High Blocking Voltage with Low On-Resistance
- $R_{DS(ON)}$ = 64m Ω (TYP.) @V_{GS}= 20V
- High Speed Switching with Low Capacitance
- Avalanche Ruggedness

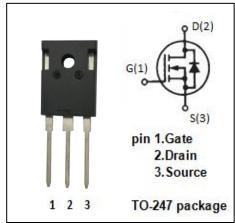
APPLICATIONS

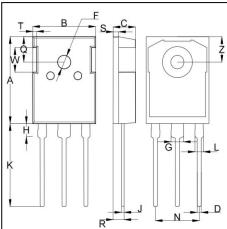


- Motor Drives
- · Solar Inverters, UPS
- Down Hole Drilling
- · Battery Chargers

Absolute Maximum Ratings(TC=25℃)

| SYMBOL | PARAMETER | VALUE | UNIT | |
|------------------|--|---------|--------------|--|
| V_{DSS} | Drain-Source Voltage | 1700 | V | |
| V _G s | Gate-Source voltage | -10/+22 | V | |
| I _D | Drain Current-Continuous | 43 | А | |
| | Drain Current-Continuous @Tc=100°C | 32 | А | |
| I _{DM} | Drain Current-Single Pluse | 129 | А | |
| P _D | Total Dissipation @T _C =25℃ | 313 | W | |
| TJ | Max. Operating Junction Temperature | 175 | $^{\circ}$ | |
| T _{stg} | Storage Temperature -58 | | $^{\circ}$ C | |





| DIM | mm | | | |
|-----|-------|-------|-------|--|
| DIM | MIN | TYP. | MAX | |
| Α | 19.80 | 20.65 | 21.50 | |
| В | 15.40 | 15.65 | 15.90 | |
| C | 4.70 | 5.00 | 5.30 | |
| D | 0.90 | 1.08 | 1.26 | |
| F | 3.50 | 3.70 | 3.90 | |
| G | 2.70 | 3.00 | 3.30 | |
| Н | 3.90 | 4.00 | 4.10 | |
| J | 0.50 | 0.60 | 0.70 | |
| K | 19.50 | 20.00 | 20.50 | |
| L | 1.90 | 2.05 | 2.20 | |
| N | 10.80 | 10.90 | 11.00 | |
| Q | 6.00 | 6.15 | 6.30 | |
| R | 2.90 | 3.10 | 3.30 | |
| S | 1.80 | 2.00 | 2.20 | |
| T | 2.15 | 2.25 | 2.35 | |
| W | 4.90 | 5.00 | 5.10 | |
| Z | 6.00 | 6.15 | 6.30 | |



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THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | MAX | UNIT |
|---------------------|--------------------------------------|------|------|
| R _{th j-c} | Thermal Resistance, Junction to Case | 0.48 | °C/W |

ELECTRICAL CHARACTERISTICS (Tc=25°C)

| SYMBOL | PARAMETER | CONDITIONS | MIN | TYP. | MAX | UNIT |
|----------------------|----------------------------------|---|------|------|------|--------------|
| V _{(BR)DSS} | Drain-Source Breakdown Voltage | V _{GS} = 0V; I _D = 1mA | 1700 | | | V |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{DS} = V_{GS;}$ $I_D = 1mA$ | 1.8 | 3.0 | | V |
| R _{DS(on)} | Drain-Source On-stage Resistance | V _{GS} = 20V; I _D = 20A;T _C = 25°C | | 64 | 86 | - m Ω |
| | | V _{GS} = 20V; I _D = 20A;T _C = 150°C | | 104 | | |
| I _{GSS} | Gate Source Leakage Current | V _{GS} = -10/+22V; V _{DS} = 0V | | | ±100 | nA |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} = 1700V; V _{GS} = 0V; T _C = 25°C | | | 10 | μA |
| V _{SD} | Diode Forward Voltage | I _{SD} = 10A; V _{GS} = 0V | | 3.8 | | V |
| t _{rr} | Reverse Recovery Time | V _R = 1000V, V _{GS} = 0V | | 15 | | ns |
| Qrr | Reverse Recovery Charge | l _D = 25A di/dt = 100A/us | | 300 | | nC |

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